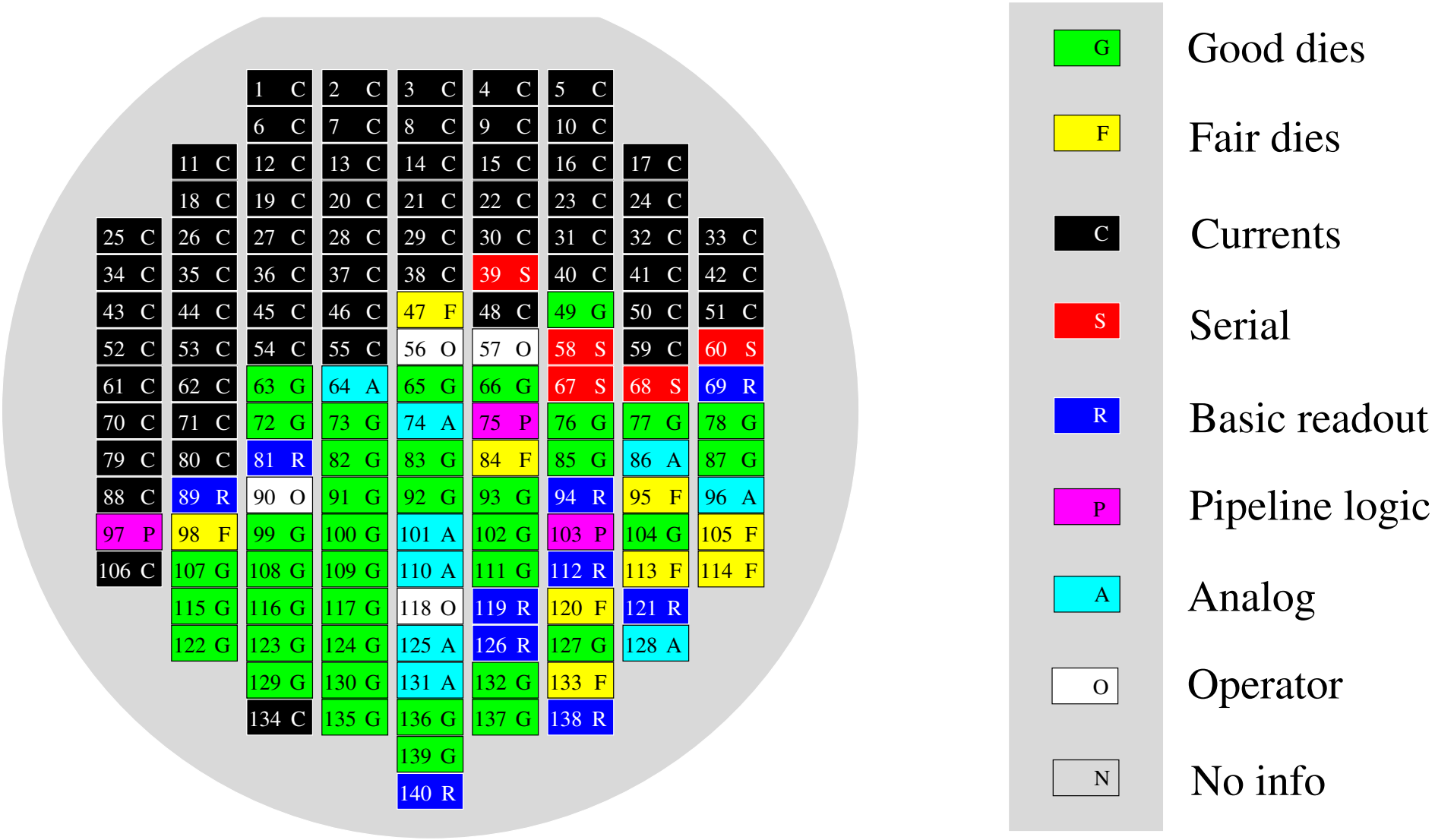
Types of die failures for wafer 248 s/n: Y21316-08-02

Date: 12/22/99